ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoo nternational and Pan-Ameri	kburn, Illinois	s. All rights reser	ation with		parts, the	declaration	n encom	passes all		als for which	the item is an assembly the manufacturer has seclaration.			
IPC-1752-2 v1.02 1752-2							Form Type * Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa						
Supplier Information																
Company Name * AVX Corporation		Company Unique ID		Unique ID A	uthority	-	onse Dat 04-27	e *	F	Response D	ocument ID					
Contact Name * Dennis Oldland		Title - Contact corporate env. mgr		Phone - Contact * 18439460241		doldl	Email - Contact * doldland@avxus.com			Duplicate Contact -> Authorized Representative						
Authorized Representat Dennis Oldland	ive *	Title - Representative corporate env. mgr	е	Phone - Re 1843946024	presentative [•] 41		l - Repres and@avx	sentative i cus.com	*	Supplier Co	mments or URL	or Additiona	I Information			
Requester Item Number	er	Mfr Item Number		Mfr Item Nam	ne	Effecti	ve Date	Version	Manufac	cturing Site	Weight	UOM	Unit Type			
									JERUS.	ALEM	9.438	mg	Each			
Alternate Recommend	lation	0805xxxxxxBTTR		0805 ACCU	J family	2006-	2006-12-05 Alternate			Item Comments Family data sheets encompass request						
Manufacturing Proce	ss In	formation														
,			Terminal B	, l			ting Peak Process Body Temperature 260 (ture Max Ti	•	rature Numb	ture Number of Reflow Cycles ds 3			
Comments			1				1									

Save the fields in this form to a file Export Data Import fields from a file into this form Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent changes	Lock Supplier Fields			
RoHS Material Composition Declaration			Declaration Type *	Detailed			
RoHS Directive 2002/95/EC RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.1% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.1% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) in homogeneral Polybrominated Diphenyl Ethers (PBDE) and quanti				ated Biphenyls (PBB),			
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the pa Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with Europear provided by others in completing this form, and that Supplier may not have independently verified such information. However suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as compreh If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of to source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides Conditions of Sale applicable to such part shall apply.	of the applicable quantity limit rt is an assembly with lower I that such information is true a Union member state laws th in situations where Supplier ensive as the certification in that agreement, including any	identified above. If a homoger evel components, the declaration and correct to the best of its known at implement the RoHS Direction has not independently verified this paragraph.	neous material within the part contains a on shall encompass all such components owledge and belief, as of the date that S ve. Company acknowledges that Suppli information provided by others, Supplier es provided as part of that agreement, wi	RoHS restricted substance in s. upplier completes this form. er may have relied on information agrees that, at a minimum, its ill be the sole and exclusive			
RoHS Declaration * 1 - Item(s) does not contain RoHS restricted substances per the definition above			Supplier Acceptance Accept	ed			
Exemptions: If the declared item does not contain RoHS restricted substances per the definition ababove and checkboxes will appear below. Check all applicable exemptions.	ove except for defined	RoHS exemptions, then	select the corresponding respon	se in the RoHS Declaration			
Mercury in compact fluorescent lamps not exceeding 5 mg per lamp.	7c. Lead in electronic	ceramic parts (e.g. piezo	electronic devices).				
2a. Mercury in straight fluorescent lamps for general purposes not exceeding 10 mg in halophosphate lamps	8. Cadmium and its compounds in electrical contacts and cadmium plating except for applications banned under Directive 91/338/EEC amending Directive 76/769/EEC relating to restrictions on the marketing and use of certain dangerous substances and preparations piezoelectronic devices).						
2b. Mercury in straight fluorescent lamps for general purposes not exceeding 5 mg in triphosphate lamps with a normal lifetime	Hexavalent chromium as an anti-corrosion of the carbon steel cooling system in absorption refrigerators						
2c. Mercury in straight fluorescent lamps for general purposes not exceeding 8 mg in triphosphate lamps with long lifetime	10a. Deca BDEin poly	meric applications					
3. Mercury in straight fluorescent lamps for special purposes.	10b. Lead in lead-bro	onze bearing shells					
4. Mercury in other lamps not specifically mentioned in this list.	11. Lead used in com	pliant pin connector syste	ems.				
5. Lead in glass of cathode ray tubes, electronic components and fluorescent tubes.	12. Lead as a coating	g material for a thermal co	onduction module c-ring.				
6a. Lead as an alloying element in steel containing up to 0.35% lead by weight.	13a. Lead in optical a	and filter glass.					
6b. Lead as an alloying element in aluminum containing up to 0.4% lead by weight.	13b. Cadmium in opti	cal and filter glass.					
14. Lead in solders consisting of more than two elements for the connection between the pins and package of microprocessors with a lead content of more than 80% and less than 85% by weight.							
7a. Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).		o complete a viable electr uit Flip Chip packages.	ical connection between semicon	ductor die and carrier			
7b. Lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signalling, transmission as well as network management for telecommunications.							
Declaration Signature							

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +P Inserts a New Part +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Evennt	Weight	Unit of	Tolerance		PPM
	Name		Material Weight Mea		Measure		Level		Substance Category			Substance	CAS	Exempt	weight	Measure	-	+	
+P -P	CAPTR 0805 ACCU +	-M	element	0.043	mg	+C	-C	Supplier	alumina	+S	-S	AI2O3	1344-28-1		0.042	mg	50	50	976,74
	_					+C	-C	Supplier	copper	+S	-S	Cu	7440-50-8		0.001	mg	50	50	23,256
	4	-M	glue	0.026	mg	+C	-C	Supplier	ероху	+S	-S	bisphenol F	28064-14-4		0.0249	mg	50	50	961,00
						+C	Ģ	Supplier	ероху	+S	-S	imidazole	288-32-4		0.0011	mg	50	50	39,000
	+	-M	substrate	8.675	mg	+C	-C	Supplier	barium	+S	-S	Barium oxide (BaO)	1304-28-5		0.11	mg	50	50	12,680
						+C	Ģ	Supplier	calcium	+S	-S	Calcium oxide (CaO)	1305-78-8		0.06	mg	50	50	6,916
						+C	-Ç	Supplier	silicon	+S	-S	Silicon oxide (SiO2)	112945-52-5		0.225	mg	50	50	25,937
						+C	-C	Supplier	alumina	+S	-S	AI2O3	1344-28-1		8.28	mg	50	50	954,46
	•	-М -М	termination	0.694	mg	+C	-C	Supplier	chromium	+S	-S	Cr	7440-47-3		0.003	mg	50	50	4,323
	_					+C	-C	Supplier	nickel	+S	-S	Ni	7440-02-0		0.121	mg	50	50	174,35
						+C	-C	Supplier	tin	+S	-S	Sn	7440-31-5		0.55	mg	50	50	792,50
						+C	-C	Supplier	silver	+S	-s	Ag	7440-22-4		0.02	mg	50	50	28,818

Homogeneous Material Composition Declaration for Electronic Products

Requester Instructions: The requester can optionally include additional substance categories and substances that must be declared for the item on this form. This is in addition to JIG Level A and JIG Level B substances already included for the JIG section. The requester should enter additional substance categories and then enter name of the substance and the CAS number. These entries will be accessible to the supplier via Level drop-down by selecting "Requester". Use the Load "Requester" and Test button to view the entries, just select "Requester" in the Level drop-down list in the previous section.

	Substance Category				Substance	CAS			
+C -	-C		+S	-S					
Upd	late	Level "Requester" ar	nd T	est	Clear Level "Re	quester" values			